

WEBENCH[®] Thermal Simulation Report

Design : 3943919/57 TPS43060RTER
TPS43060RTER 10.0V-17.5V to 25.20V @ 4.0A

Operating Condition

Name	Value
VIN_OP	10.0V
IOUT_OP	4.0A

Ambient Temperature

Name	Temperature
Ambient_plus_Z	30.0
Ambient_minus_Z	30.0

Air Flow

Name	Direction
Flow_Type	Convection
Flow_Rate	0.0LFM
Flow_Direction	Top to Bottom




Edge Temperature






Name	Temperature	Thermal Type
Edge_plus_X (Right)		Insulated
Edge_minus_X (Left)		Insulated
Edge_plus_Y (Top)		Insulated
Edge_minus_Y (Bottom)		Insulated

My Comments

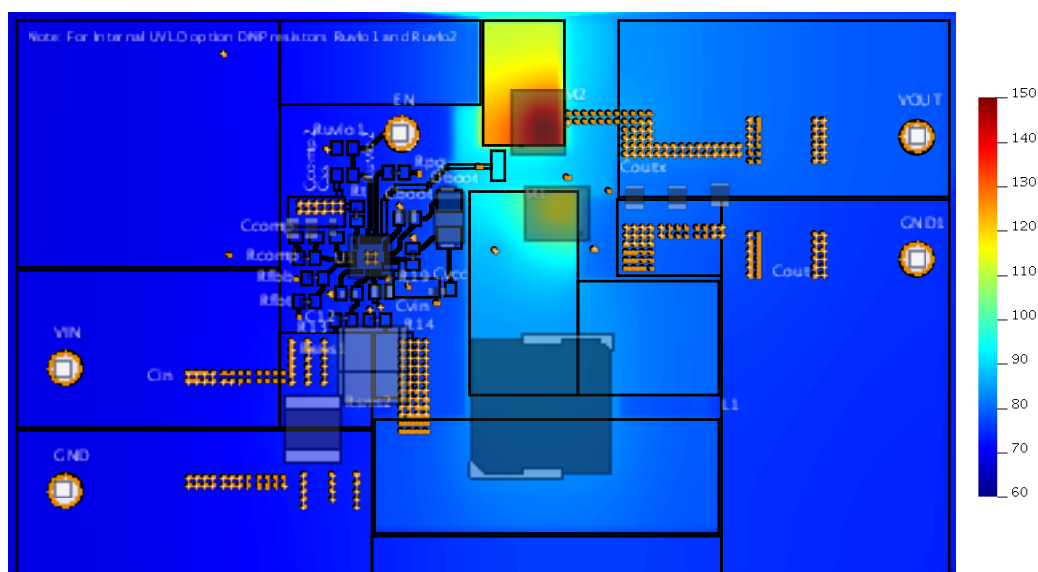
No comments

BOM

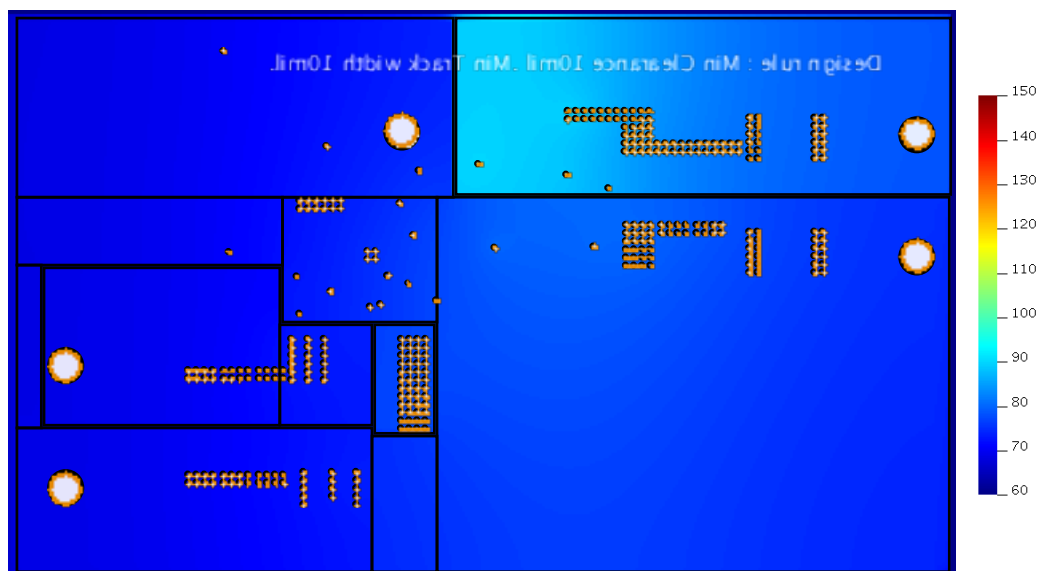
Component Name(s)	Part Number	Max Temp	Power Dissipation	Manufacture	Properties	Qty	Price	Footprint
Rsns1	PMR100HZPFU8L00	77°C	0.218W	Rohm		1	\$0.16	 2512 43.16 mm ²
pcb_bottom		91°C						
M1	CSD18504Q5A	115°C	1.346W	Texas Instruments	VdsMax=40.0V IdsMax=50.0Amps	1	\$0.37	 TRANS_NexFET_Q5A 55.2 mm ²
M2	CSD18504Q5A	148°C	1.887W	Texas Instruments	VdsMax=40.0V IdsMax=50.0Amps	1	\$0.37	 TRANS_NexFET_Q5A 55.2 mm ²

Component Name(s)	Part Number	Max Temp	Power Dissipation	Manufacture	Properties	Qty	Price	Footprint
L1	SRP1270-4R7M	85°C	1.527W	Bourns	L=4.7E-6H DCR=0.0112Ohm	1	\$0.6	 SRP1270 246.49 mm ²
Rsns2	PMR100HZPFU8L00	77°C	0.218W	Rohm		1	\$0.16	 2512 43.16 mm ²
Cin	KCM55WR7YA336MH01K	73°C	0.00W	MuRata	VDC=35.0V ESR=0.0Ohm IRMS=0.0A Cap=3.3E-5F	1	\$1.51	 KCM55W 59.13 mm ²
Cout	GRM32ER71J106KA12L	81°C	0.00W	MuRata	VDC=63.0V ESR=0.0Ohm IRMS=0.0A Cap=1.0E-5F	3	\$0.27	 1210_280 14.7 mm ²
U1	TPS43060RTER	76°C	0.095W	Texas Instruments		1	\$1.25	 S-PVQFN-N16 16.81 mm ²
pcb_top		148°C						

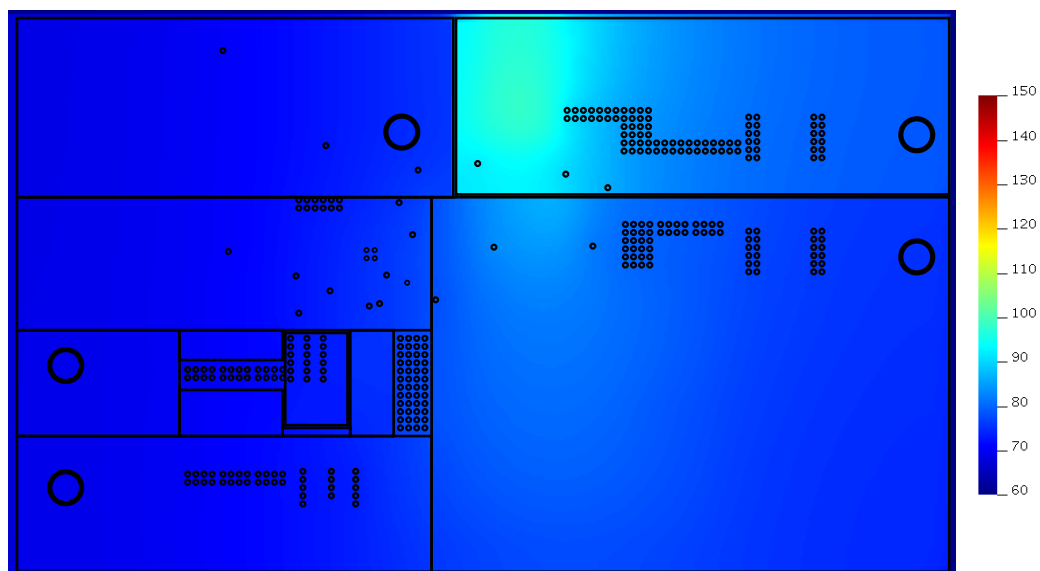
Thermal Images



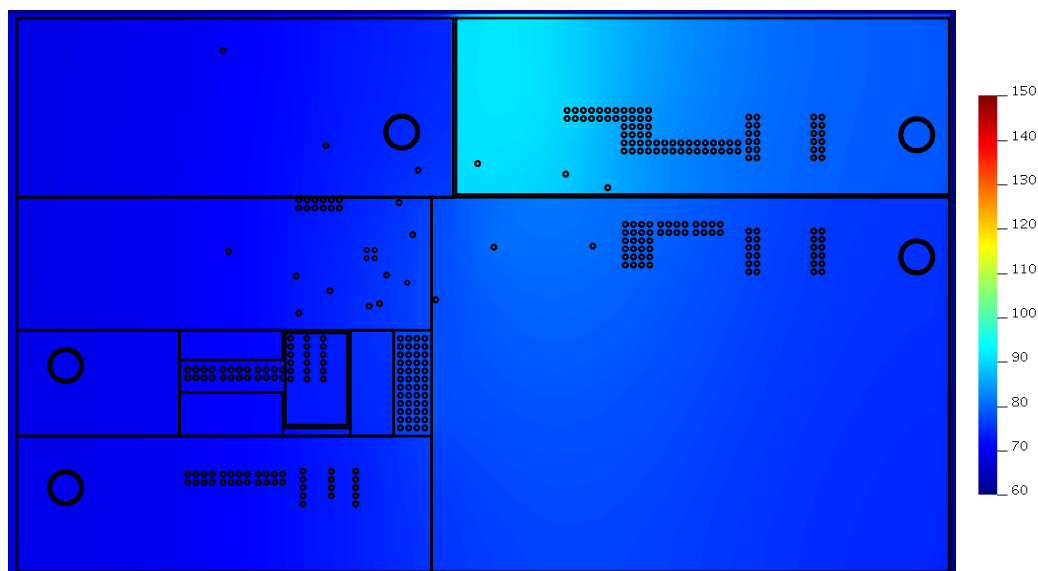
Thermal Top Image



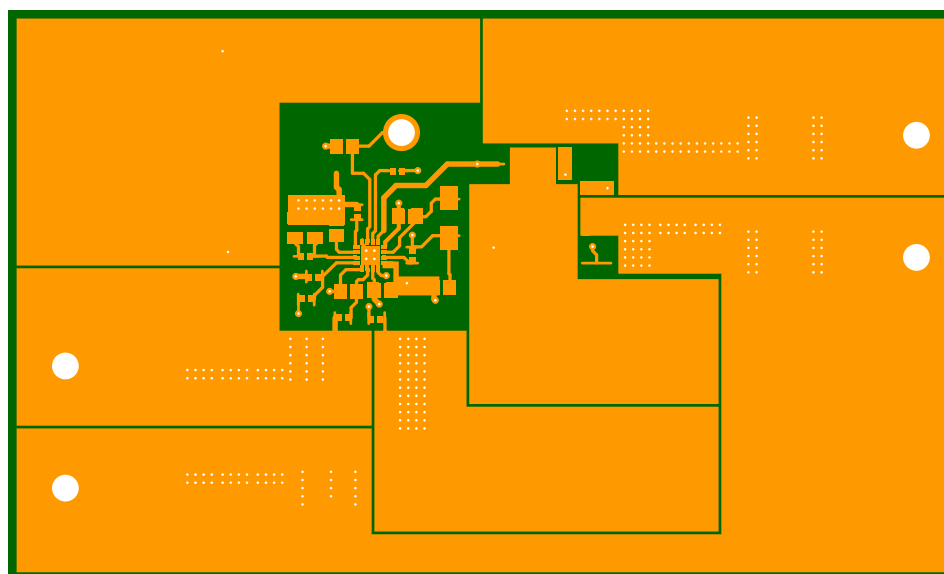
Thermal Bottom Image



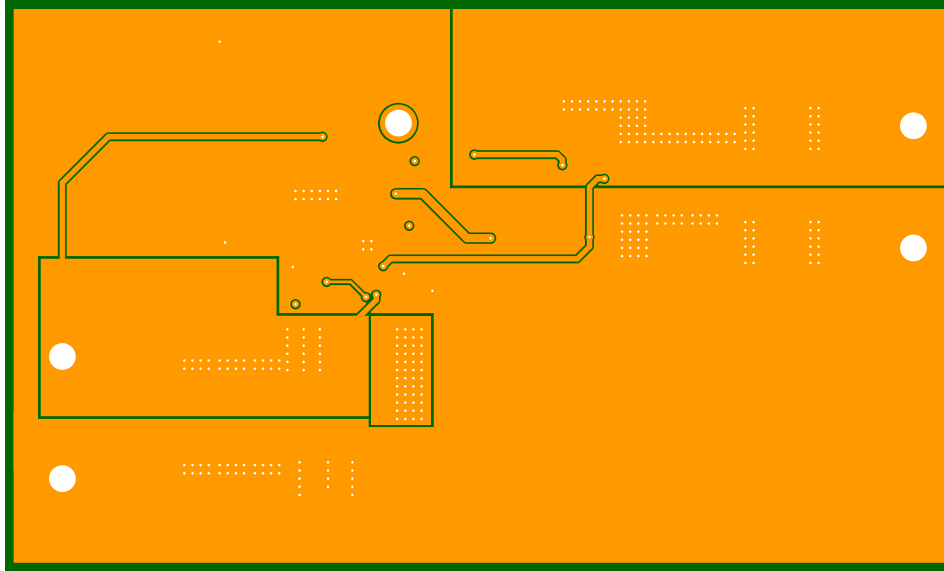
Thermal MID1 Image



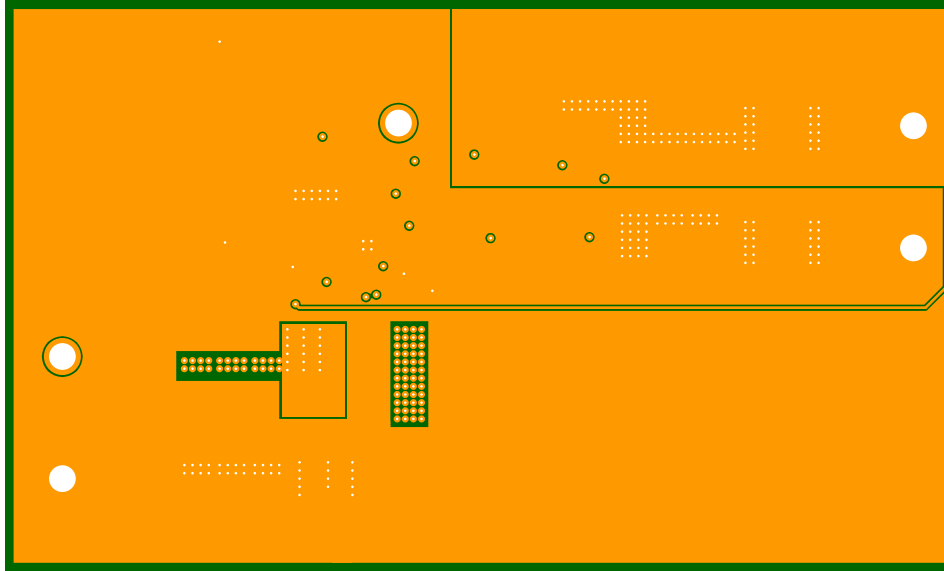
Thermal MID2 Image



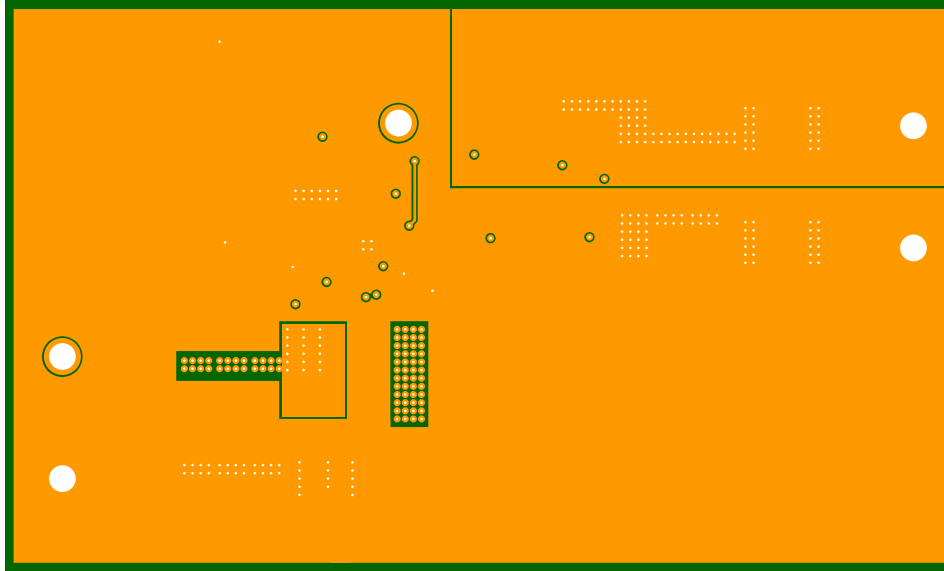
PCB Top Image



PCB Bottom Image



PCB MID1 Image



PCB MID2 Image

